P-Channel 20-V (D-S) MOSFET with Schottky Diode

PRODUCT SUMMARY			
V_{DS} (V)	$R_{DS(on)}$ (Ω)	I_D (A)[a]	Q_g (Typ.)
- 20	0.070 at V_{GS} = - 5.0 V	- 5.0	4.5 nC
	0.105 at V_{GS} = - 2.5 V	- 4.2	

SCHOTTKY PRODUCT SUMMARY		
V_{KA} (V)	V_f (V) Diode Forward Voltage	I_F (A)[a]
20	0.45 at 1 A	2

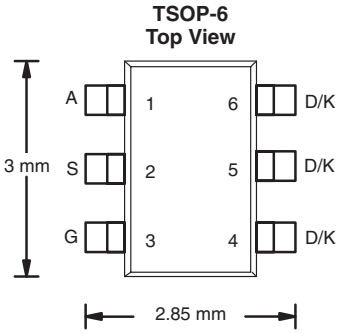
FEATURES

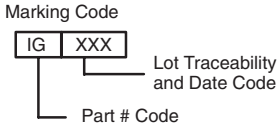
- **Halogen-free According to IEC 61249-2-21 Definition**
- LITTLE FOOT® *Plus* Schottky Power MOSFET
- Compliant to RoHS Directive 2002/95/EC

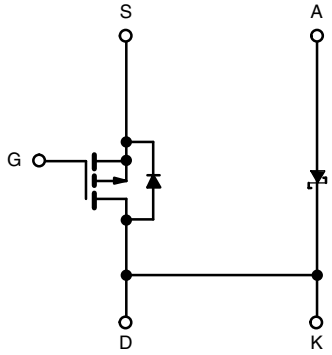
Pb-free
RoHS COMPLIANT
HALOGEN FREE Available

APPLICATIONS

- HDD
  - DC-DC Converter
- Asynchronous Rectification







P-Channel MOSFET

Ordering Information: Si3879DV-T1-E3 (Lead (Pb)-free)
Si3879DV-T1-GE3 (Lead (Pb)-free and Halogen-free)

ABSOLUTE MAXIMUM RATINGS T_A = 25 °C, unless otherwise noted				
Parameter		**Symbol**	**Limit**	**Unit**
Drain-Source Voltage (MOSFET)		V_{DS}	- 20	V
Reverse Voltage (Schottky)		V_{KA}	20	
Gate-Source Voltage (MOSFET)		V_{GS}	± 12	
Continuous Drain Current (T_J = 150 °C) (MOSFET)	T_C = 25 °C	I_D	- 5.0	A
	T_C = 70 °C		- 4.0	
	T_A = 25 °C		- 4.0[b, c]	
	T_A = 70 °C		- 3.0[b, c]	
Pulsed Drain Current (MOSFET)		I_{DM}	- 20	
Continuous Source-Drain Diode Current (MOSFET Diode Conduction)	T_C = 25 °C	I_S	- 2.7	
	T_A = 25 °C		- 1.6[b, c]	
Average Forward Current (Schottky)		I_F	2[b]	
Pulsed Forward Current (Schottky)		I_{FM}	5	
Maximum Power Dissipation (MOSFET)	T_C = 25 °C	P_D	3.3	W
	T_C = 70 °C		2.1	
	T_A = 25 °C		2.0[b, c]	
	T_A = 70 °C		1.2[b, c]	
Maximum Power Dissipation (Schottky)	T_C = 25 °C		1.9	
	T_C = 70 °C		1.2	
	T_A = 25 °C		1.3[b, c]	
	T_A = 70 °C		0.9[b, c]	
Operating Junction and Storage Temperature Range		T_J, T_{stg}	- 55 to 150	°C

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THERMAL RESISTANCE RATINGS

Parameter		Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient (MOSFET)[b, d]	t ≤ 5 s	R_{thJA}	51	62.5	°C/W
Maximum Junction-to-Foot (Drain) (MOSFET)	Steady State	R_{thJF}	30	37	
Maximum Junction-to-Ambient (Schottky)[b, e]	t ≤ 5 s	R_{thJA}	73	90	
Maximum Junction-to-Foot (Drain) (Schottky)	Steady State	R_{thJF}	50	65	

Notes:
a. Based on T_C = 25 °C.
b. Surface Mounted on 1" x 1" FR4 board.
c. t = 5 s.
d. Maximum under Steady State conditions is 105 °C/W.
e. Maximum under Steady State conditions is 125 °C/W.

SPECIFICATIONS T_J = 25 °C, unless otherwise noted

Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V_{DS}	V_{GS} = 0 V, I_D = - 250 µA	- 20			V
V_{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	I_D = - 250 µA		- 20		mV/°C
$V_{GS(th)}$ Temperature Coefficient	$\Delta V_{GS(th)}/T_J$			3		
Gate-Source Threshold Voltage	$V_{GS(th)}$	V_{DS} = V_{GS}, I_D = - 250 µA	- 0.6		- 1.5	V
Gate-Source Leakage	I_{GSS}	V_{DS} = 0 V, V_{GS} = ± 12 V			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS} = - 20 V, V_{GS} = 0 V			- 1	µA
		V_{DS} = - 20 V, V_{GS} = 0 V, T_J = 55 °C			- 10	
On-State Drain Current[a]	$I_{D(on)}$	V_{DS} ≤ 5 V, V_{GS} = - 4.5 V	- 8			A
Drain-Source On-State Resistance[a]	$R_{DS(on)}$	V_{GS} = - 4.5 V, I_D = - 3.5 A		0.058	0.070	Ω
		V_{GS} = - 2.5 V, I_D = - 3.0 A		0.085	0.105	
Forward Transconductance[a]	g_{fs}	V_{DS} = - 10 V, I_D = - 3.5 A		10		S
Dynamic[b]						
Input Capacitance	C_{iss}	V_{DS} = - 10 V, V_{GS} = 0 V, f = 1 MHz		480		pF
Output Capacitance	C_{oss}			132		
Reverse Transfer Capacitance	C_{rss}			55		
Total Gate Charge	Q_g	V_{DS} = - 10 V, V_{GS} = - 10 V, I_D = - 5.0 A		9.7	14.5	nC
		V_{DS} = - 10 V, V_{GS} = - 4.5 V, I_D = - 4.5 A		4.5	7	
Gate-Source Charge	Q_{gs}			1.0		
Gate-Drain Charge	Q_{gd}			1.0		
Gate Resistance	R_g	f = 1 MHz		7.5		Ω
Turn-On Delay Time	$t_{d(on)}$	V_{DD} = - 10 V, R_L = 2.0 Ω I_D ≅ - 5.0 A, V_{GEN} = - 10 V, R_g = 1 Ω		6	10	ns
Rise Time	t_r			54	85	
Turn-Off DelayTime	$t_{d(off)}$			19	30	
Fall Time	t_f			8	15	
Turn-On Delay Time	$t_{d(on)}$	V_{DD} = - 10 V, R_L = 2.0 Ω I_D ≅ - 5.0 A, V_{GEN} = - 4.5 V, R_g = 1 Ω		26	40	
Rise Time	t_r			80	120	
Turn-Off DelayTime	$t_{d(off)}$			20	30	
Fall Time	t_f			10	15	

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SPECIFICATIONS T_J = 25 °C, unless otherwise noted						
Parameter	**Symbol**	**Test Conditions**	**Min.**	**Typ.**	**Max.**	**Unit**
Drain-Source Body Diode Characteristics						
Continuous Source-Drain Diode Current	I_S	T_C = 25 °C			- 2.7	A
Pulse Diode Forward Current	I_{SM}				- 20	
Body Diode Voltage	V_{SD}	I_S = - 1.0 A, V_{GS} = 0 V		- 0.75	- 1.2	V
Body Diode Reverse Recovery Time	t_{rr}	I_F = - 3.5 A, dI/dt = 100 A/µs, T_J = 25 °C		25	40	ns
Body Diode Reverse Recovery Charge	Q_{rr}			12	20	nC
Reverse Recovery Fall Time	t_a			9		ns
Reverse Recovery Rise Time	t_b			16		

Notes:
a. Pulse test; pulse width ≤ 300 µs, duty cycle ≤ 2 %.
b. Guaranteed by design, not subject to production testing.

SCHOTTKY SPECIFICATIONS						
Parameter	**Symbol**	**Test Conditions**	**Min.**	**Typ.**	**Max.**	**Unit**
Forward Voltage Drop	V_F	I_F = 1 A		0.41	0.45	V
		I_F = 1 A, T_J = 125 °C		0.36	0.41	
Maximum Reverse Leakage Current	I_{rm}	V_R = 5 V		0.015	0.08	mA
		V_R = 5 V, T_J = 85 °C		0.50	5.00	
		V_R = 20 V		0.02	0.10	
		V_R = 20 V, T_J = 85 °C		0.7	7.00	
		V_R = 20 V, T_J = 125 °C		5	50	
Junction Capacitance	C_T	V_R = 10 V		60		pF

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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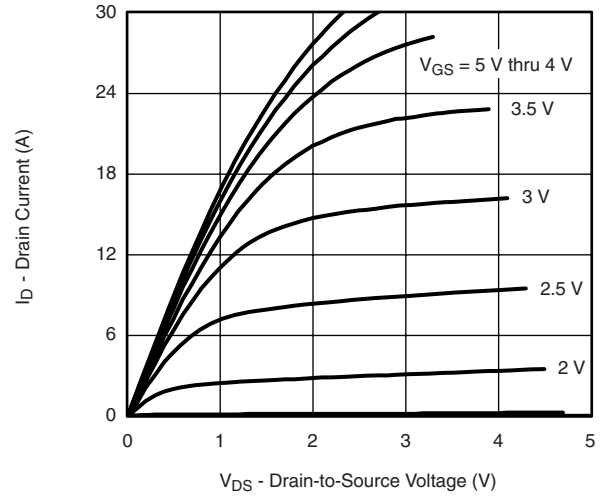
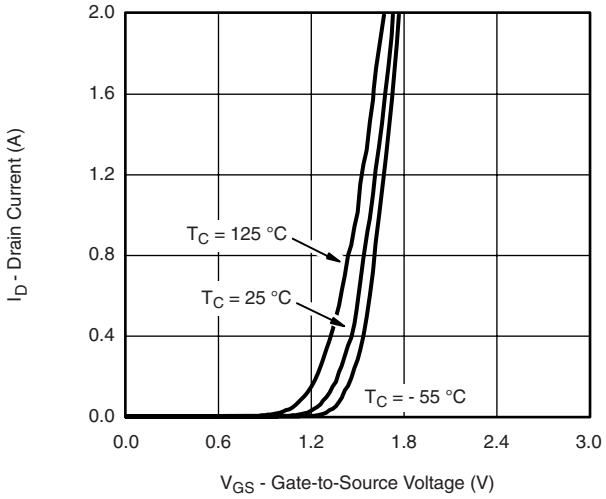
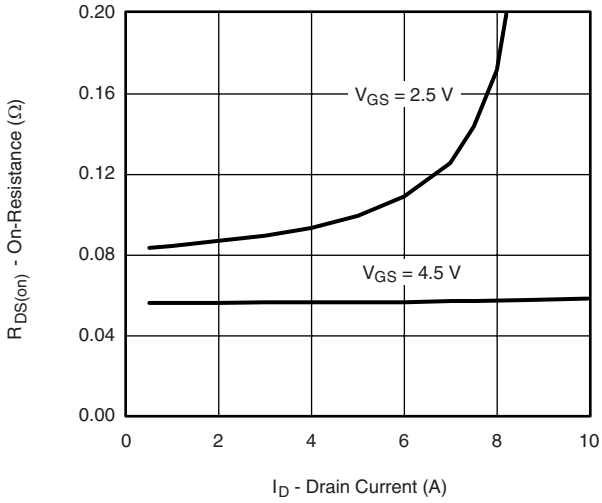
MOSFET TYPICAL CHARACTERISTICS T_A = 25 °C, unless otherwise noted



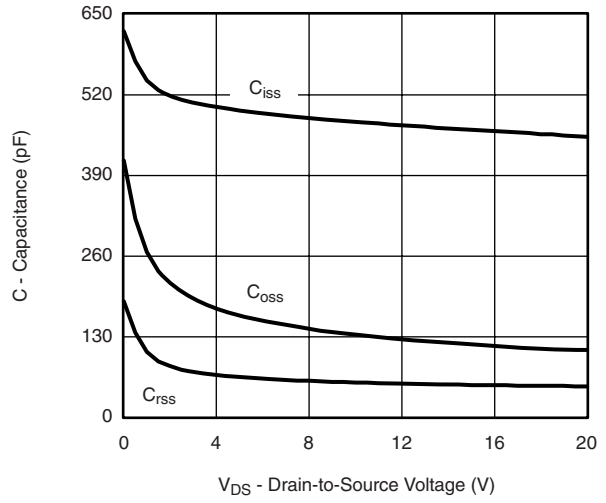
Output Characteristics



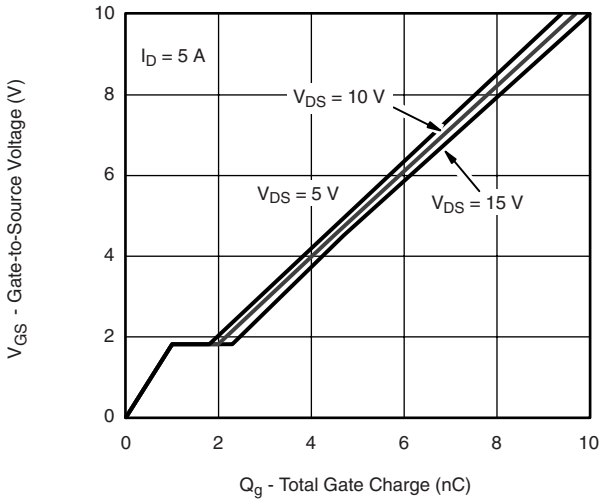
Transfer Characteristics



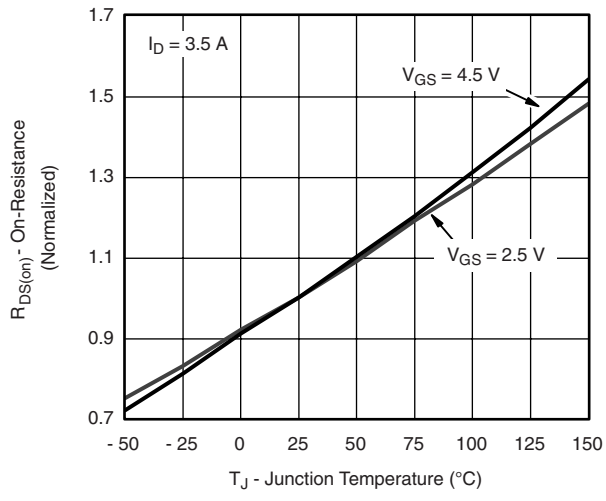
On-Resistance vs. Drain Current and Gate Voltage



Capacitance



Gate Charge



On-Resistance vs. Junction Temperature

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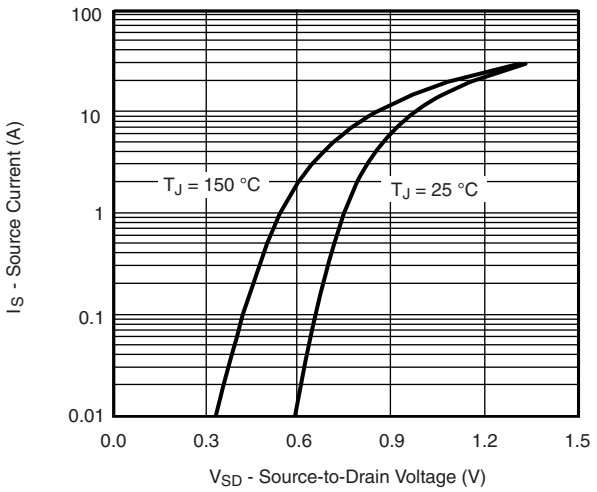
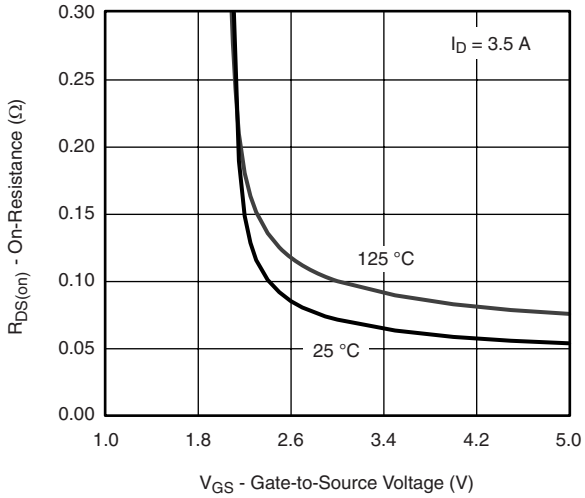
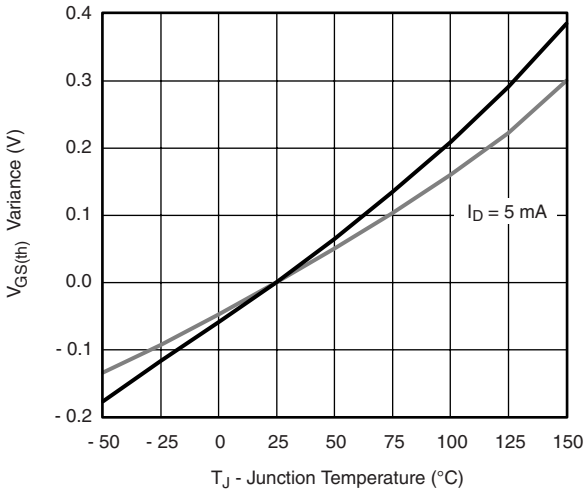
MOSFET TYPICAL CHARACTERISTICS T_A = 25 °C, unless otherwise noted



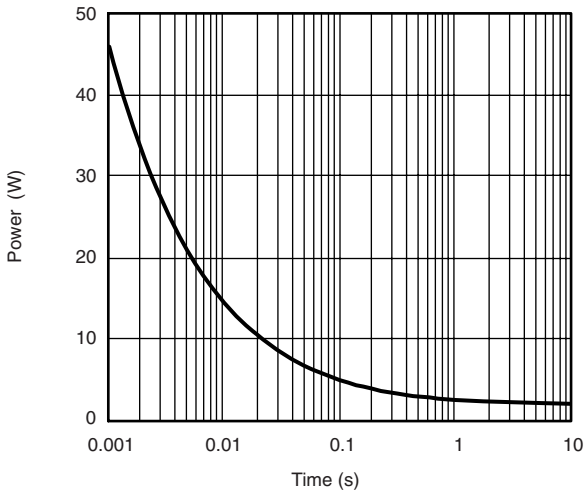
Soure-Drain Diode Forward Voltage



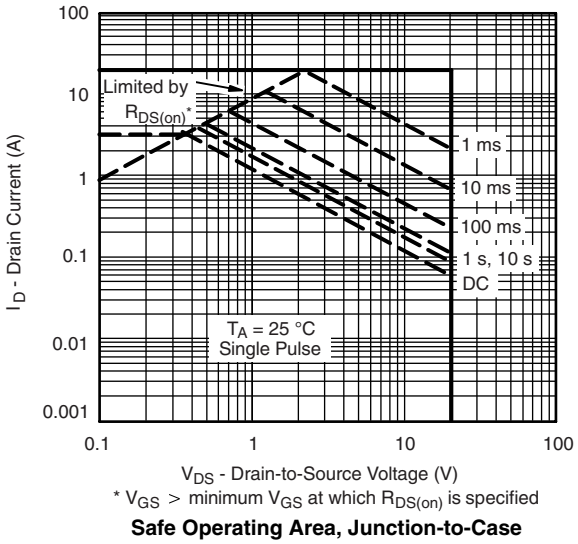
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



Single Pulse Power, Junction-to-Ambient



* V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

Safe Operating Area, Junction-to-Case

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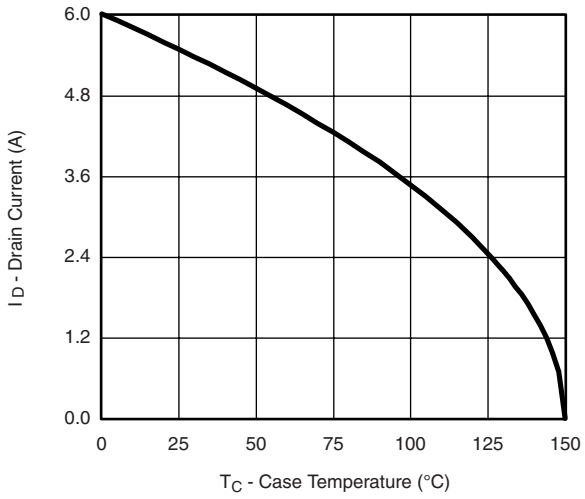
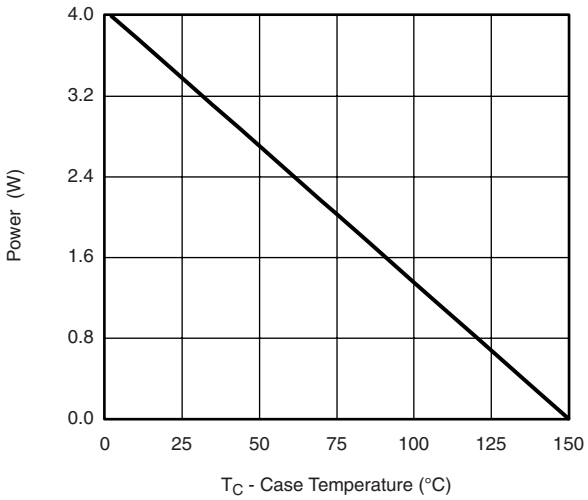
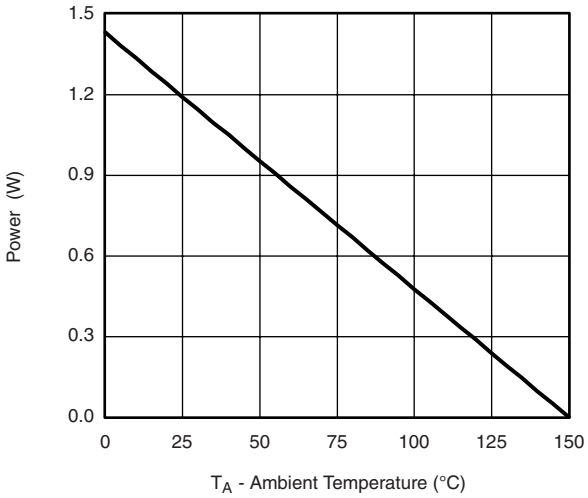
MOSFET TYPICAL CHARACTERISTICS T_A = 25 °C, unless otherwise noted



Current Derating*



Power Derating, Junction-to-Foot



Power Derating, Junction-to-Ambient

* The power dissipation P_D is based on $T_{J(max)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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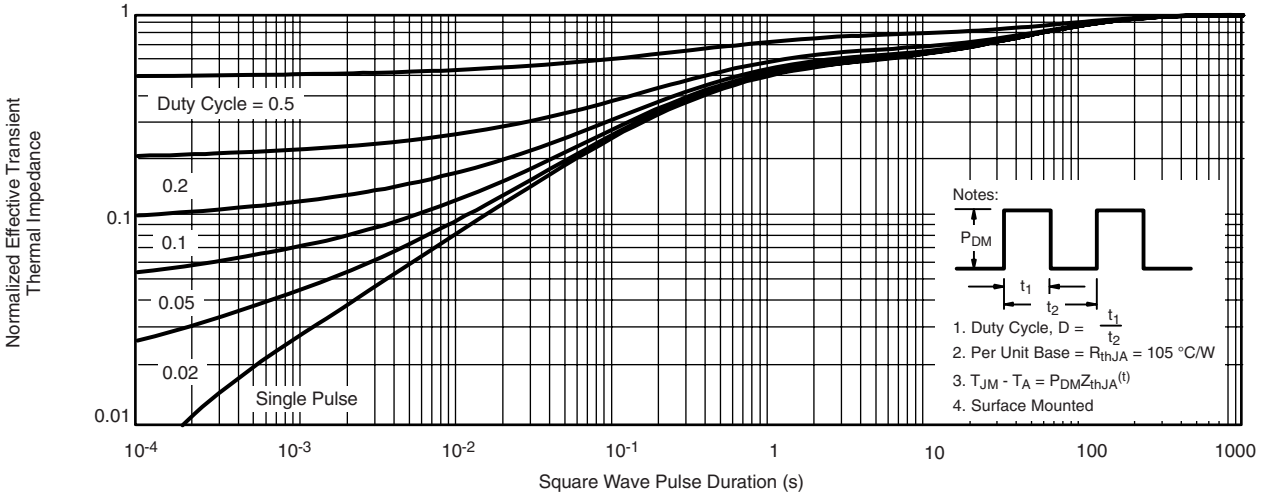
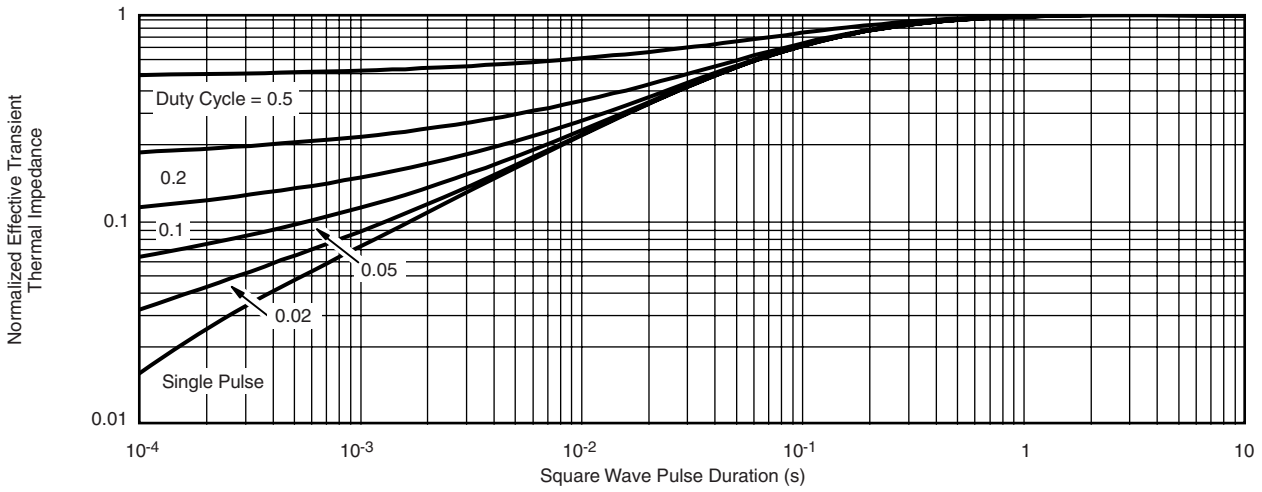
MOSFET TYPICAL CHARACTERISTICS T_A = 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

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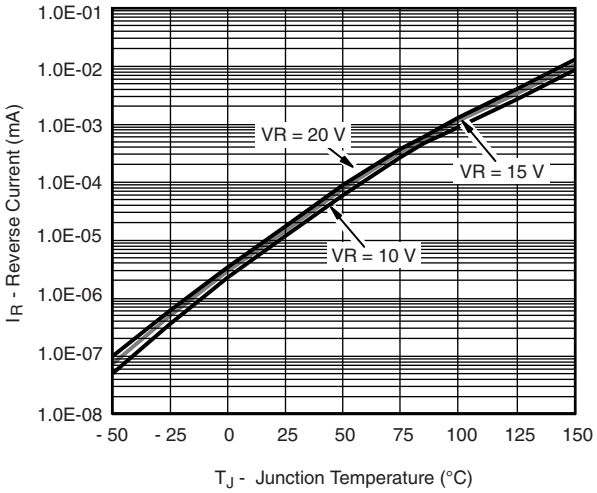
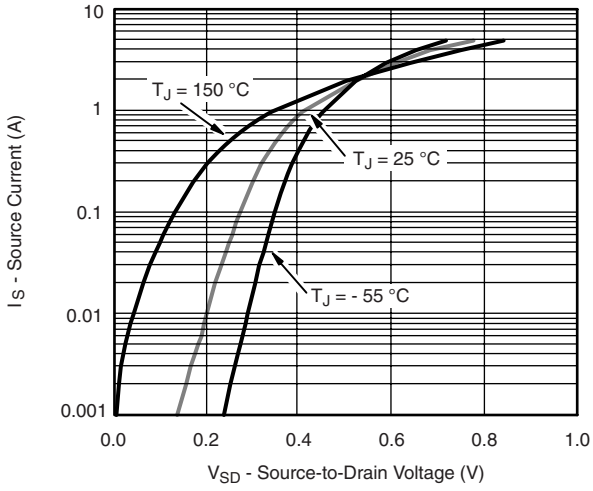
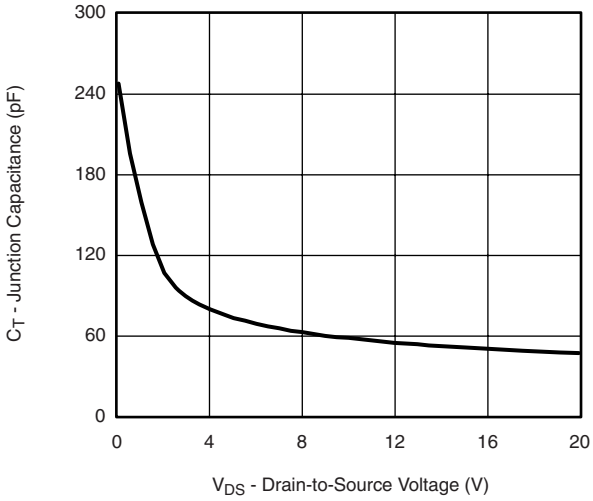
SCHOTTKY TYPICAL CHARACTERISTICS T_A = 25 °C, unless otherwise noted



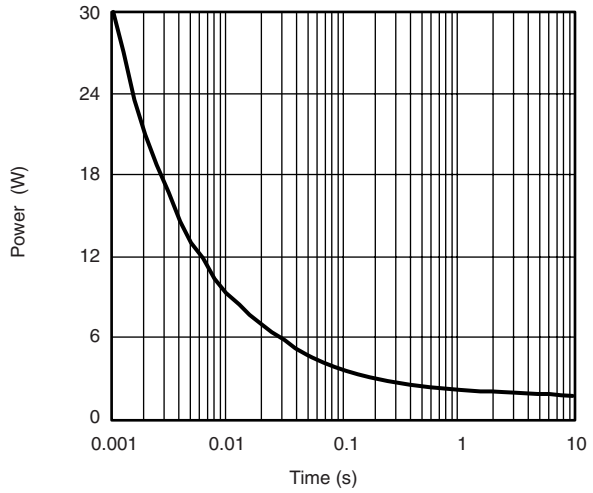
Reverse Current vs. Junction Temperature



Forward Diode Voltage



Capacitance



Single Pulse Power, Junction-to-Ambient

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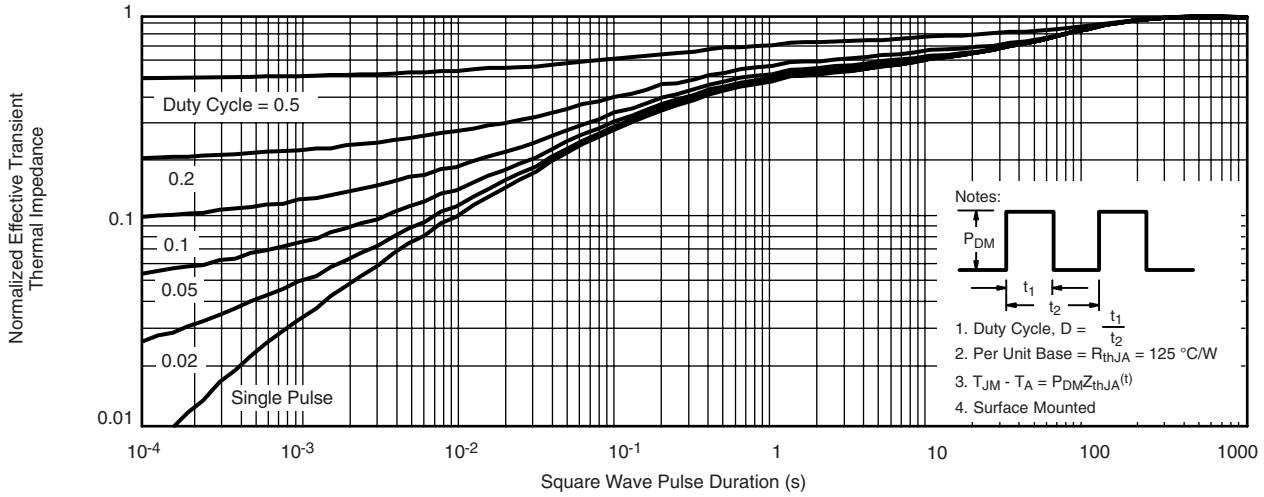
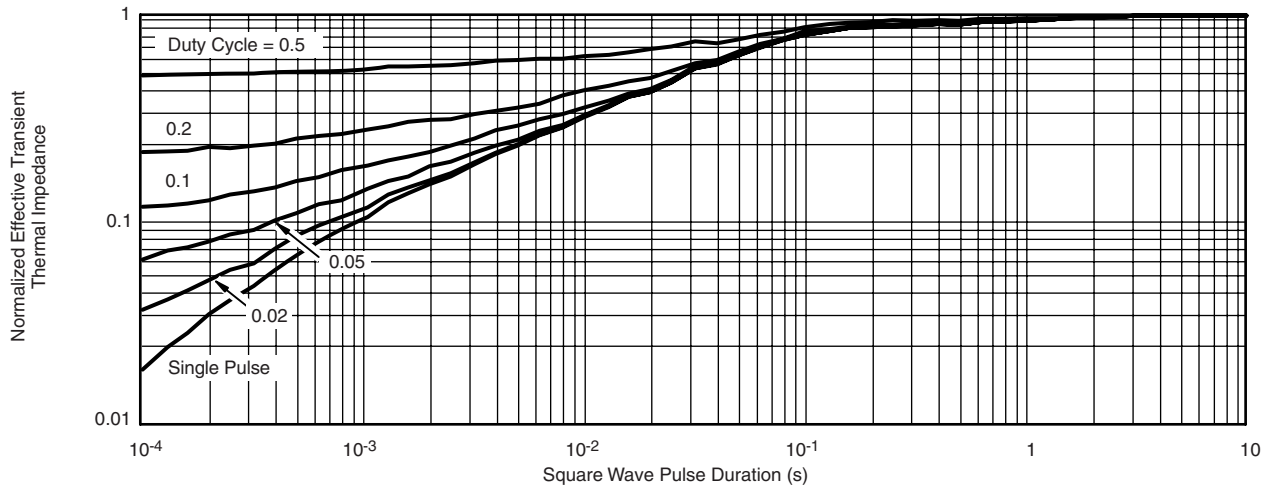
SCHOTTKY TYPICAL CHARACTERISTICS T_A = 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

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